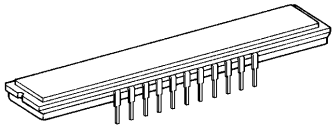
TOSHIBA CCD LINEAR IMAGE SENSOR CCD (Charge Coupled Device)

TCD1501D

The TCD1501D which includes sample-and-hold circuit is a high sensitive and low dark current 5000 elements CCD image sensor.
The sensor is designed for facsimile, imagescanner and OCR.
The device contains a row of 5000 elements photodiodes which provide a 16 lines / mm (400DPI) across a A3 size paper. The device is operated by 5 V (pulse), and 12 V power supply.



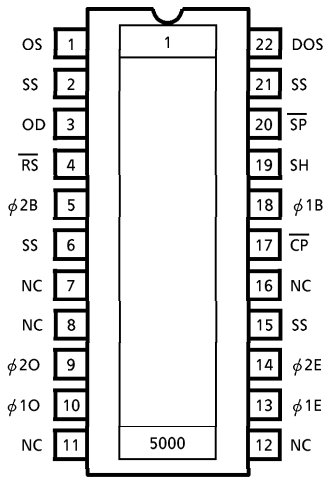
WDIP22-G-400-2.54D (B)

Weight : 5.2 g (Typ.)

FEATURES

- Number of Image Sensing Elements : 5000 elements
- Image Sensing Element Size : 7 μm by 7 μm on 7 μm centers
- Photo Sensing Region : High sensitive and low voltage dark signal pn photodiode
- Clock : 2 Phase (5 V)
- Internal Circuit : S / H circuit
- Package : 22 pin Cerdip

PIN CONNECTIONS



(TOP VIEW)

MAXIMUM RATINGS (Note 1)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Clock Pulse Voltage	V_ϕ	−0.3~8	V
Shift Pulse Voltage	V_{SH}		
Reset Pulse Voltage	$V_{\overline{RS}}$		
Clamp Pulse Voltage	$V_{\overline{CP}}$		
Sample and Hold Pulse Voltage	$V_{\overline{SP}}$		
Power Supply Voltage	V_{OD}	−0.3~15	
Operating Temperature	T_{opr}	−25~60	°C
Storage Temperature	T_{stg}	−40~100	°C

(Note 1) : All voltage are with respect to SS terminals (Ground).

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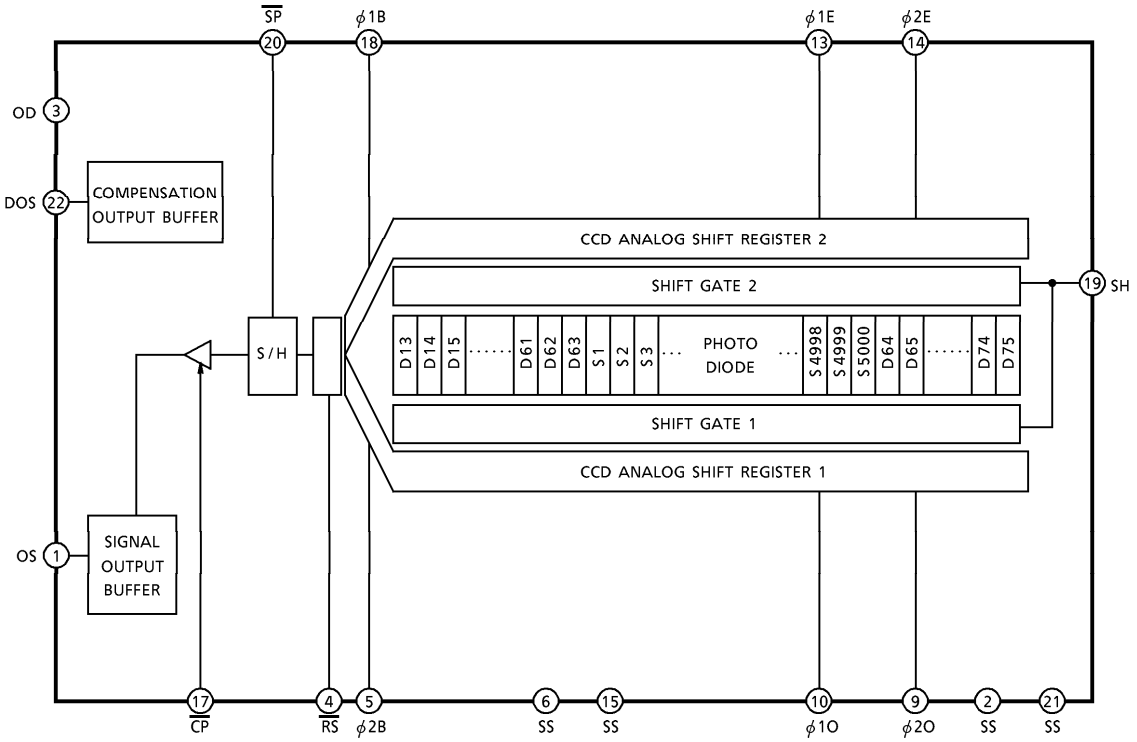
CIRCUIT DIAGRAM



PIN NAME

ϕ1E, O	Clock (Phase 1)
ϕ2E, O	Clock (Phase 2)
ϕIB	Final Stage Clock (Phase 1)
ϕ2B	Final Stage Clock (Phase 2)
SH	Shift Gate
$\overline{RS}$	Reset Gate
$\overline{SP}$	Sample and Hold Gate
$\overline{CP}$	Clamp Gate
OS	Signal Output
DOS	Compensation Output
OD	Power
SS	Ground
NC	Non Connection

OPTICAL / ELECTRICAL CHARACTERISTICS

(Ta = 25°C, V_{OD} = 12 V, V_{ϕ} = $V_{\overline{RS}}$ = V_{SH} = $V_{\overline{SP}}$ = $V_{\overline{CP}}$ = 5 V, f_{ϕ} = 0.5 MHz, f_{RS} = 1 MHz, t_{INT} (INTEGRATION TIME) = 10 ms, LIGHT SOURCE = DAYLIGHT FLUORESCENT LAMP, LOAD RESISTANCE = 100 kΩ)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	NOTE
Sensitivity	R	10.4	13	15.6	V / lx·s	
Photo Response Non Uniformity	PRNU	—	—	10	%	(Note 2)
	PRNU (3)	—	6	10	mV	(Note 9)
Register Imbalance	RI	—	—	3	%	(Note 3)
Saturation Output Voltage	V_{SAT}	2	3	—	V	(Note 4)
Saturation Exposure	SE	0.13	0.23	—	lx·s	(Note 5)
Dark Signal Voltage	V_{DRK}	—	1	2	mV	(Note 6)
Dark Signal Non Uniformity	DSNU	—	2	3	mV	(Note 6)
DC Power Dissipation	P_D	—	240	325	mW	
Total Transfer Efficiency	TTE	92	—	—	%	
Output Impedance	Z_o	—	0.5	1	kΩ	
Dynamic Range	DR	—	3000	—	—	(Note 7)
DC Signal Output Voltage	V_{OS}	4	5	6.5	V	(Note 8)
DC Compensation Output Voltage	V_{DOS}	4	5	6.5	V	(Note 8)
DC Differential Error Voltage	$\lvert V_{OS}\text{-}V_{DOS}\rvert$	—	—	400	mV	

(Note 2) : Measured at 50% of SE (Typ.)

Definition of PRNU : $PRNU = \frac{\Delta\chi}{\overline{\chi}} \times 100\,(\%)$

Where $\overline{\chi}$ is average of total signal output and $\Delta\chi$ is the maximum deviation from $\overline{\chi}$ under uniform illumination.

(Note 3) : Measured at 50% of SE (Typ.)
RI is defined as follows:

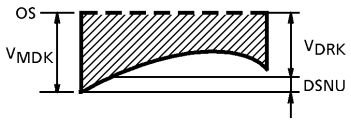
$$RI = \frac{\sum_{n=1}^{4999} |\chi n - \chi n + 1|}{4999 \times \overline{\chi}} \times 100\,(\%)$$

Where χn and $\chi n + 1$ are signal output of each pixel. $\overline{\chi}$ is average of total signal output.

(Note 4) : V_{SAT} is defined as minimum saturation output voltage of all effective pixels.

(Note 5) : Definition of SE : $SE = \frac{V_{SAT}}{R}$ (l x·s)

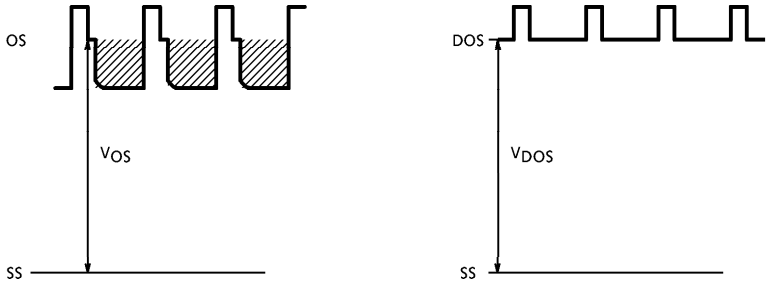
(Note 6) : V_{DRK} is defined as average dark signal voltage of all effective pixels.
DSNU is defined as different voltage between V_{DRK} and V_{MDK} when V_{MDK} is maximum dark signal voltage.



(Note 7) : Definition of DR : $DR = \frac{V_{SAT}}{V_{DRK}}$

V_{DRK} is proportional to t_{INT} (Integration Time).
So the shorter t_{INT} condition makes wider DR values.

(Note 8) : DC signal output voltage and DC compensation output voltage are defined as follows:



(Note 9) : PRUN (3) is defined as maximum voltage with next pixel, where measured 5% of SE (Typ.).

OPERATING CONDITION

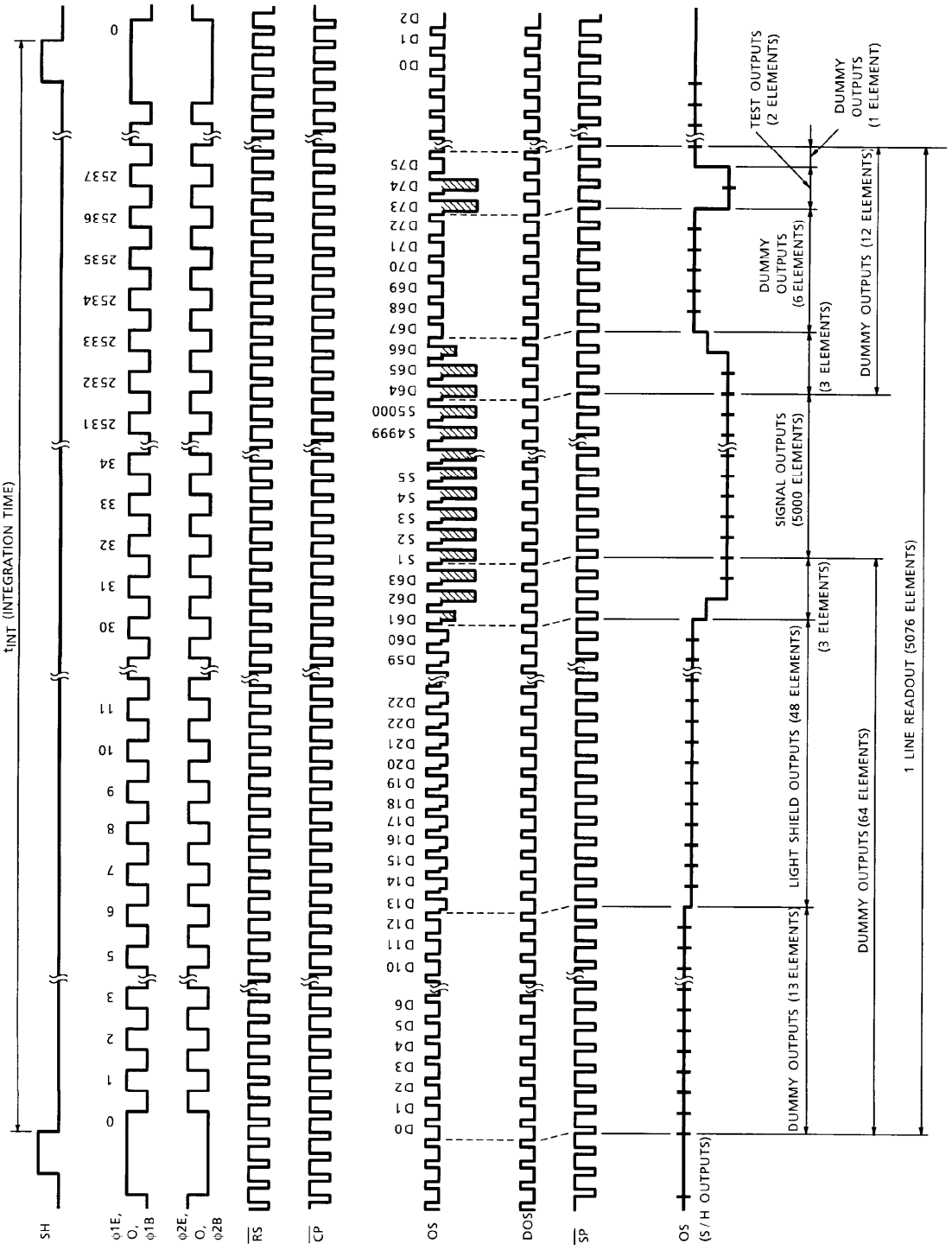
CHARACTERISTIC		SYMBOL	MIN.	TYP.	MAX.	UNIT
Clock Pulse Voltage	"H" Level	$V_{\phi}1E, O$	4.5	5	5.5	V
	"L" Level	$V_{\phi}2E, O$	0	—	0.5	
Final Stage Clock Voltage	"H" Level	$V_{\phi}1B$	4.5	5	5.5	V
	"L" Level	$V_{\phi}2B$	0	—	0.5	
Shift Pulse Voltage	"H" Level	V_{SH}	4.5	5	5.5	V
	"L" Level		0	—	0.5	
Reset Pulse Voltage	"H" Level	V_{RS}	4.5	5	5.5	V
	"L" Level		0	—	0.5	
Clamp Pulse Voltage	"H" Level	V_{CP}	4.5	5	5.5	V
	"L" Level		0	—	0.5	
Sample and Hold Pulse Voltage *	"H" Level	V_{SP}	4.5	5	5.5	V
	"L" Level		0	—	0.5	
Power Supply Voltage		V_{OD}	11.4	12.0	13.0	V

* : Supply "L" level to $\overline{SP}$ terminal when sample-and-hold circuitry is not used.

CLOCK CHARACTERISTICS (Ta = 25°C)

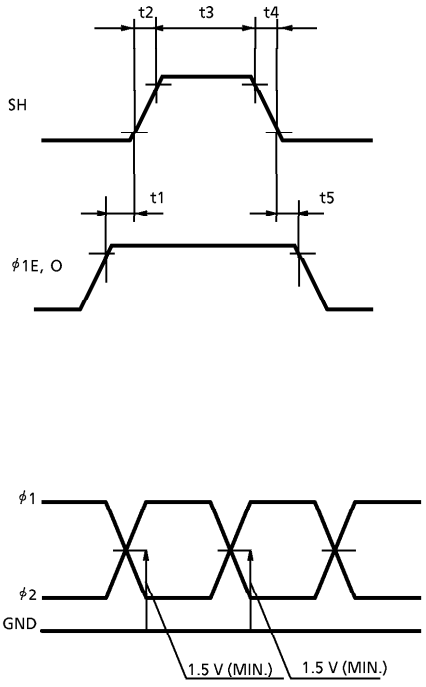
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Clock Pulse Frequency	f_{ϕ}	—	0.5	6.0	MHz
Reset Pulse Frequency	$f_{\overline{RS}}$	—	1.0	12.0	MHz
Sample and Hold Pulse Frequency	$f_{\overline{SP}}$	—	1.0	2.0	MHz
Clock Capacitance	$C_{\phi}E$	—	350	450	pF
	$C_{\phi}O$	—	350	450	
Final Stage Clock Capacitance	$C_{\phi}B$	—	10	20	pF
Shift Gate Capacitance	C_{SH}	—	10	20	pF
Reset Gate Capacitance	$C_{\overline{RS}}$	—	10	20	pF
Clamp Gate Capacitance	$C_{\overline{CP}}$	—	10	20	pF
Sample and Hold Gate Capacitance	$C_{\overline{SP}}$	—	10	20	pF

TIMING CHART

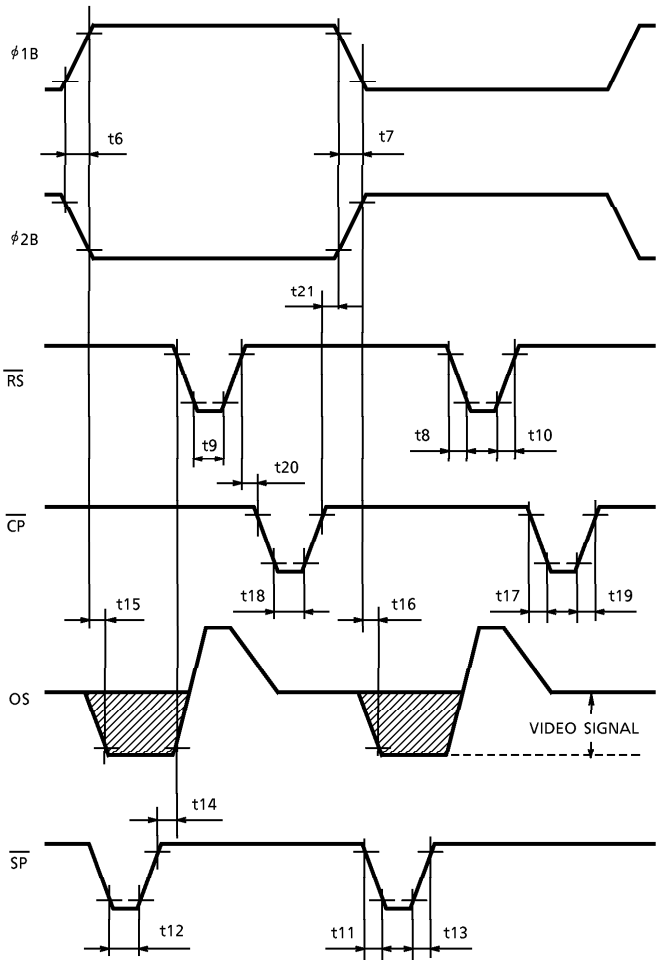


TIMING REQUIREMENTS

SH, ϕ1 TIMING



ϕ1, ϕ2, $\overline{RS}$, $\overline{CP}$, OS, $\overline{SP}$ TIMING

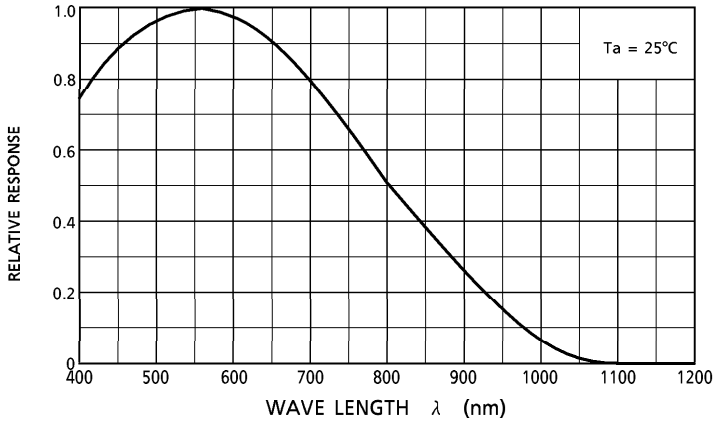


CHARACTERISTIC	SYMBOL	MIN.	TYP. (Note 10)	MAX.	UNIT
Pulse Timing of SH and ϕ10, E	t1, t5	100	300	—	ns
SH Pulse Rise Time, Fall Time	t2, t4	0	50	—	ns
SH Pulse Width	t3	500	1000	—	ns
ϕ1, ϕ2 Pulse Rise Time, Fall Time	t6, t7	0	100	—	ns
$\overline{RS}$ Pulse Rise Time, Fall Time	t8, t10	0	20	—	ns
$\overline{RS}$ Pulse Width	t9	20	250	—	ns
$\overline{SP}$ Pulse Rise Time, Fall Time	t11, t13	0	20	—	ns
$\overline{SP}$ Pulse Width	t12	20	—	—	ns
Pulse Timing of $\overline{SP}$ and $\overline{RS}$	t14	0	50	—	ns
Video Data Delay Time (Note 11)	t15, t16	—	30	—	ns
$\overline{CP}$ Pulse Rise Time, Fall Time	t17, t19	0	20	—	ns
$\overline{CP}$ Pulse Width	t18	20	—	—	ns
Pulse Timing of $\overline{RS}$ and $\overline{CP}$	t20	0	—	—	ns
Pulse Timing of ϕ1B, ϕ2B and $\overline{CP}$	t21	0	—	—	ns

(Note 10) : TYP. is the case of f_{RS} = 1.0 MHz
(Note 11) : Load Resistance is 100 kΩ

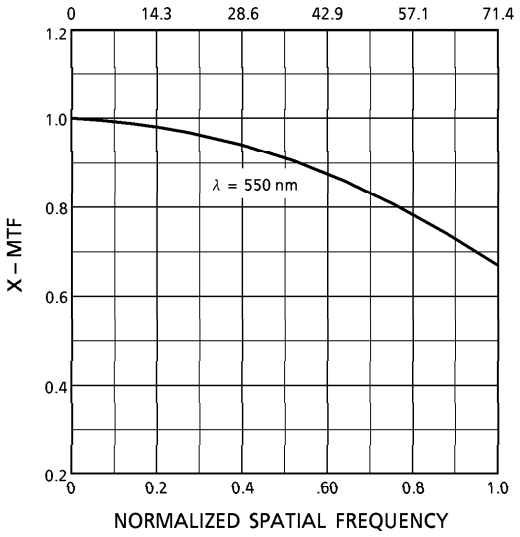
TYPICAL PERFORMANCE CURVES

SPECTRAL RESPONSE



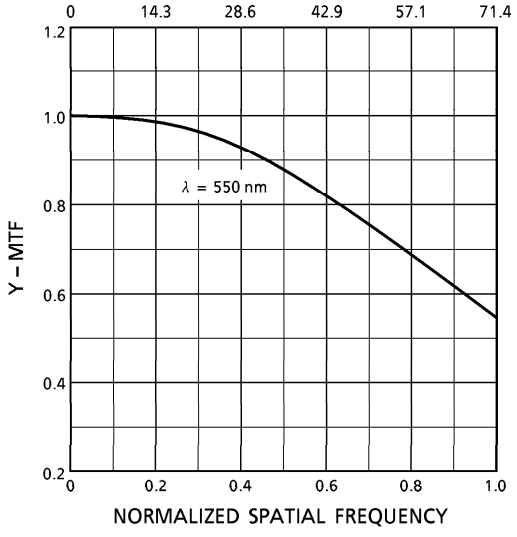
MODULATION TRANSFER FUNCTION
OF X-DIRECTION

SPATIAL FREQUENCY (Cycles / mm)



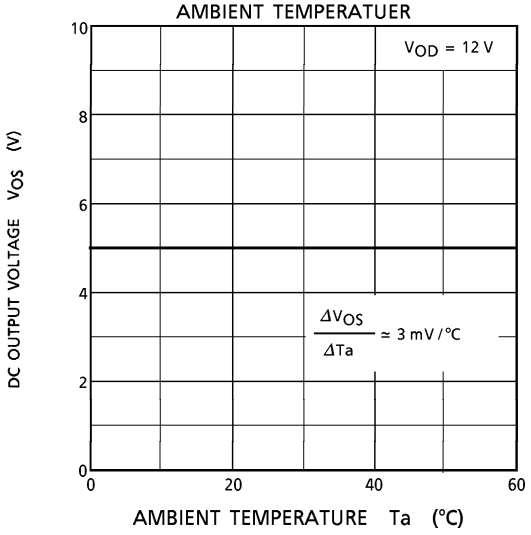
MODULATION TRANSFER FUNCTION
OF Y-DIRECTION

SPATIAL FREQUENCY (Cycles / mm)

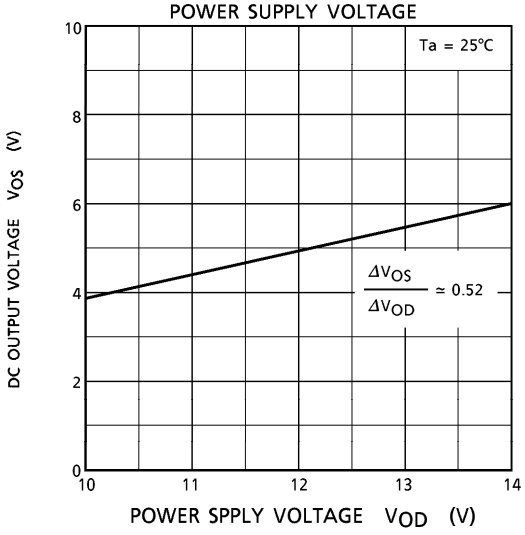


TYPICAL PERFORMANCE CURVES (Cont'd)

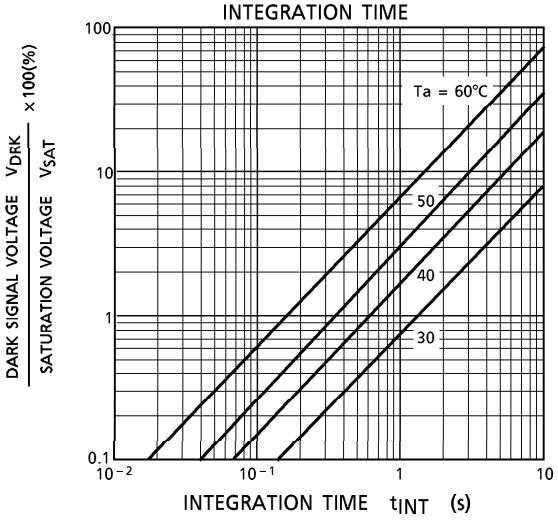
DC OUTPUT VOLTAGE VS AMBIENT TEMPERATUER



DC OUTPUT VOLTAGE VS POWER SUPPLY VOLTAGE



DARK SIGNAL VOLTAGE VS INTEGRATION TIME



PRECAUTIONS FOR USE OF CCD IMAGE SENSOR

1. Static Electricity

   This device has some weakly terminals for static electricity. Therefor, please pay attention to treat this device.

   CCD Image Sensor is protected against static electricity, but inferior puncture mode device due to static electricity is sometimes detected. In handling the device, it is necessary to execute the following static electricity preventive measures, in order to prevent the trouble rate increase of the manufacturing system due to static electricity.

   a. Prevent the generation of static electricity due to friction by making the work with bare hands or by putting on cotton gloves and non-charging working clothes.

   b. Discharge the static electricity by providing earth plate or earth wire on the floor, door or stand of the work room.

   c. Ground the tools such as soldering iron, radio cutting plier or pincette.
      It is not necessarily required to execute all precaution items for static electricity.
      It is all right to mitigate the precautions by confirming that the trouble rate within the prescribed range.

2 Window Glass

   As the dust and station on the glass window of the package will cause black flow on the picture, never fail to clean the glass surface before using. (Blow compressed vapor, and wipe off the dust, and dirt with soft cloth or paper slightly moistened with alcohol).
   Fully take care for the handling of the device as the window glass will break or a strong friction is given to the window glass surface.

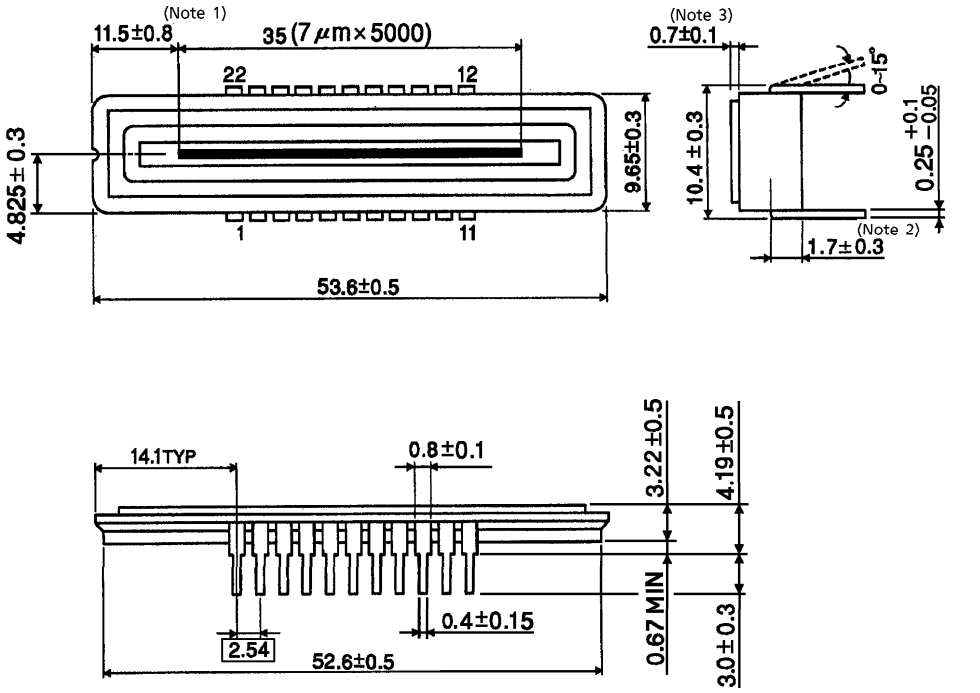
3. Incident Light

   CCD image sensor has sensitivity in a wide range zone of light wave length, but its characteristics will sometimes widely change when used with long wave length input light outside the visual light zone.

PACKAGE OUTLINE

WDIP22-G-400-2.54D (B)

Unit in mm



(Note 1) : No. 1 SENSOR ELEMENT (S1) TO EDGE OF PACKAGE.
(Note 2) : TOP OF CHIP TO BOTTOM OF PACKAGE.
(Note 3) : GLASS THICKNES (n = 1.5)

Weight : 5.2 g (Typ.)